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**ON Semiconductor®** 

# NDS9407

# 60V P-Channel PowerTrench® MOSFET

## **General Description**

This P-Channel MOSFET is a rugged gate version of ON Semiconductor's advanced PowerTrench process. It has been optimized for power management applications requiring a wide range of gate drive voltage ratings (4.5V - 20V).

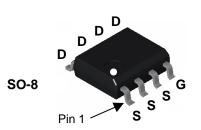
### Applications

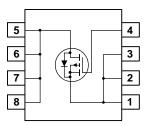
- Power management
- Load switch
- Battery protection

### Features

• -3.0 A, -60 V.  $R_{DS(ON)} = 150 \text{ m}\Omega @ V_{GS} = -10 \text{ V}$  $R_{DS(ON)} = 240 \text{ m}\Omega @ V_{GS} = -4.5 \text{ V}$ 

- Low gate charge
- · Fast switching speed
- + High performance trench technology for extremely low  $R_{\text{DS}(\text{ON})}$
- High power and current handling capability





## Absolute Maximum Ratings T<sub>A=25°C</sub> unless otherwise noted

Symbol		Parameter		Ratings	Units		
V <sub>DSS</sub>	Drain-Sour	Drain-Source Voltage			-60	V	
V <sub>GSS</sub>	Gate-Source	e Voltage			±20	V	
I <sub>D</sub>	Drain Current – Continuous			(Note 1a)	-3.0	A	
		- Pulsed			-12		
P <sub>D</sub>	Maximum Power Dissipation			(Note 1a)	2.5	W	
				(Note 1b)	1.2		
				(Note 1c)	1.0		
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Junction Temperature Range				-55 to +175	°C	
	l Charac						
$R_{ extsf{ heta}JA}$	Thermal Resistance, Junction-to-Ambient (Note 1a)			50	°C/W		
	(Note 1c)				125		
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case		Case	(Note 1)	25		
Packag	e Markin	g and Orderin	g Infor	mation			
Device Marking		Device	Ree	l Size	Tape width	Quantity	
NDS9407		NDS9407	1	3"	12mm	2500 units	

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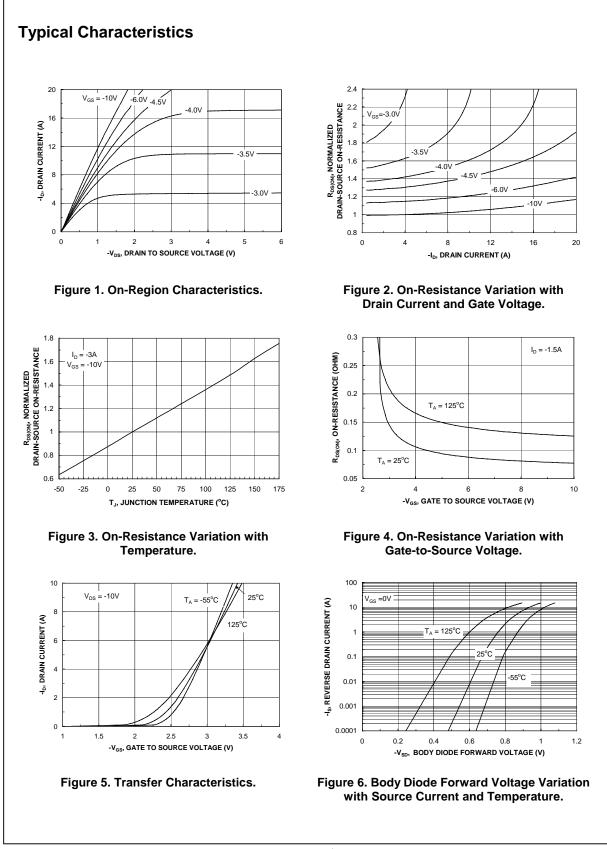
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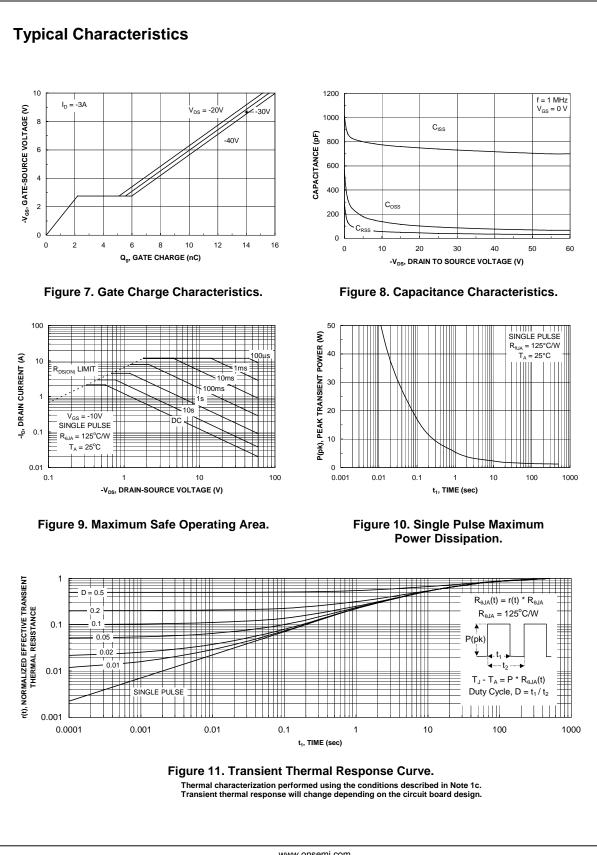
	Parameter	Test Conditions	Min	Тур	Max	Units
Off Char	acteristics					
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	$V_{GS} = 0 V$ , $I_D = -250 \mu A$	-60			V
	Breakdown Voltage Temperature	$I_D = -250 \ \mu$ A, Referenced to $25^{\circ}$ C		-45		mV/°C
$\Delta T_J$	Coefficient				4	•
DSS	Zero Gate Voltage Drain Current				-1 -10	μA
I <sub>GSSF</sub>	Gate-Body Leakage, Forward	$V_{GS} = 20 \text{ V}, \qquad V_{DS} = 0 \text{ V}$			100	nA
I <sub>GSSR</sub>	Gate–Body Leakage, Reverse	$V_{GS} = -20 \text{ V}, \qquad V_{DS} = 0 \text{ V}$			-100	nA
On Char	acteristics (Note 2)					
V <sub>GS(th)</sub>	Gate Threshold Voltage	$V_{DS} = V_{GS}$ , $I_D = -250 \ \mu A$	-1	-1.6	-3	V
$\Delta V_{GS(th)}$	Gate Threshold Voltage	$I_D = -250 \ \mu$ A, Referenced to $25^{\circ}$ C		4		mV/°C
ΔTJ	Temperature Coefficient				450	
R <sub>DS(on)</sub>	Static Drain–Source On–Resistance	$V_{GS} = -10 \text{ V},  I_D = -3.0 \text{ A}$ $V_{GS} = -4.5 \text{ V},  I_D = -1.6 \text{ A}$		78 99	150 240	mΩ
		$V_{GS} = -4.5 \text{ V},  I_D = -1.6 \text{ A}$ $V_{GS} = -10 \text{ V}, I_D = -3.0 \text{ A}, T_J = 125^{\circ}\text{C}$		99 122	240 250	
I <sub>D(on)</sub>	On–State Drain Current	$V_{GS} = -10 \text{ V},  V_{DS} = -5 \text{ V}$	-12		<u> </u>	Α
g <sub>FS</sub>	Forward Transconductance	$V_{DS} = -15 \text{ V},  I_D = -3.0 \text{ A}$		8	-	S
-				1	1	-
Dynamic C <sub>iss</sub>	Characteristics	N 00 Y N 0 Y		732		pF
	Output Capacitance	$V_{DS} = -30 \text{ V},  V_{GS} = 0 \text{ V},$ f = 1.0 MHz		86		pF
	Reverse Transfer Capacitance			38		pF
Switchin t <sub>d(on)</sub>	witching Characteristics (Note 2) $Turn-On Delay Time$ $V_{DD} = -30 V, I_D = -1 A,$				16	ns
t <sub>r</sub>	Turn-On Rise Time	$V_{\text{DD}} = -30$ V, $I_{\text{D}} = -1$ A, $V_{\text{GS}} = -10$ V, $R_{\text{GEN}} = 6 \Omega$		8 11	20	ns
t <sub>d(off)</sub>	Turn–Off Delay Time			10	20	ns
t <sub>f</sub>	Turn–Off Fall Time	-		10	20	ns
	Diode Reverse Recovery Time	$I_{\rm F} = -3.0  {\rm A},$		24		nS
t <sub>rr</sub>	Diode Reverse Recovery Charge	$d_{iF}/d_t = 100 \text{ A/}\mu\text{s}$		66		nC
	Didde Reverse Recovery onlarge			16	22	nC
Qrr	Total Gate Charge	$V_{DS} = -30 \text{ V},  I_D = -3.0 \text{ A},$				
Q <sub>rr</sub> Q <sub>g</sub>	Total Gate Charge			2.2		nC
Q <sub>rr</sub> Q <sub>g</sub> Q <sub>gs</sub>				2.2 3.3		nC nC
Q <sub>rr</sub> Q <sub>g</sub> Q <sub>gs</sub> Q <sub>gd</sub>	Total Gate Charge Gate–Source Charge Gate–Drain Charge	V <sub>GS</sub> = -10 V				
Q <sub>rr</sub> Q <sub>g</sub> Q <sub>gs</sub> Q <sub>gd</sub> Drain–So	Total Gate Charge Gate–Source Charge Gate–Drain Charge Durce Diode Characteristics	V <sub>GS</sub> = -10 V and Maximum Ratings			2 1	nC
t <sub>rr</sub> Q <sub>rr</sub> Q <sub>g</sub> Q <sub>gs</sub> Q <sub>gd</sub> Drain–Se I <sub>s</sub> V <sub>SD</sub>	Total Gate Charge Gate–Source Charge Gate–Drain Charge	V <sub>GS</sub> = -10 V and Maximum Ratings			-2.1	

**2.** Pulse Test: Pulse Width < 300 $\mu$ s, Duty Cycle < 2.0%

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